## MAY 2 2 2006 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Application Serial No	09/653,156
Confirmation No	4650
Filing Date	August 31, 2000
	Vishnu K. Agarwal et al.
Assignee	Micron Technology, Inc.
	2813
Examiner	Thanh T. Nguyen
Customer No	021567
Attornev's Docket No	Ml22-1518
	Enhanced Surface Area Capacitor Fabrication Methods

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Reference -See Attached Form PTO-1449

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

This Supplemental Information Disclosure Statement is being filed together with the filing of a Request for Continued Examination (RCE) Application. Therefore, no fee is believed to be required. However, in the event that a fee is required for filing this Supplemental Information Disclosure Statement, please charge the fee specified under 37 C.F.R. §1.17(p) to Deposit Account No. 23-0925. Please credit Deposit Account No. 23-0925 with any overpayment of the above fee.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 22 May 2006

By:

James E. Lake Reg. No. 44,854 Form PTO-1449

## U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO. MI22-1518

SERIAL NO. 09/653,156

LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)

APPLICANT: Vishnu K. Agarwal et al.

FILING DATE August 31, 2000

**GROUP** 2813

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Examiner's Initials		Document . Number	Date	Name	Class	Subclass	Filing If Appro	Date opriate
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	AB	2002/0182820 A1	12/2002	Choi et al.				
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	AN JP 2002/222934 A	08/2002	Japan			Yes	No	
	AO							
THER RE	FERFN	CES (including Author,	Title Date Pe	ertinent Pages, Etc.)	<u> </u>	<u>                                       </u>	!	<u> </u>
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	AR							
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.